

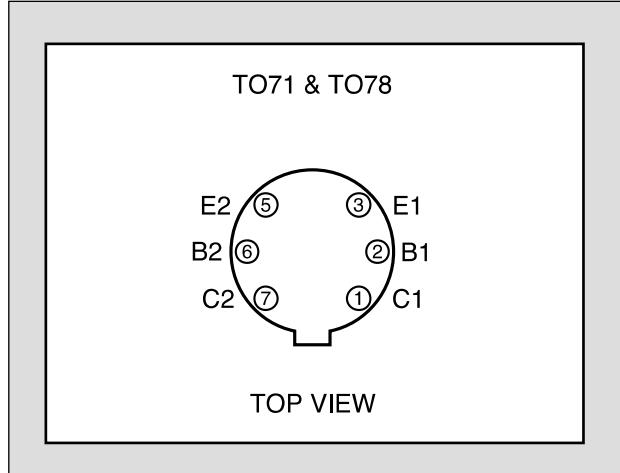
# LINEAR SYSTEMS

Twenty-Five Years Of Quality Through Innovation

## LS310 LS311 LS312 LS313

MONOLITHIC DUAL  
NPN  
TRANSISTORS

FEATURES		
VERY HIGH GAIN		$h_{FE} \geq 200 @ 10\mu A - 1mA$
TIGHT V <sub>BE</sub> MATCHING		V <sub>BE1</sub> - V <sub>BE2</sub>   = 0.2mV TYP.
HIGH f <sub>T</sub>		250MHz TYP. @ 1mA
ABSOLUTE MAXIMUM RATINGS <u>NOTE 1</u>		
@ 25°C (unless otherwise noted)		
I <sub>C</sub>	Collector Current	10mA
Maximum Temperatures		
Storage Temperature		-55° to +150°C
Operating Junction Temperature		-55° to +150°C
Maximum Power Dissipation		ONE SIDE BOTH SIDES
Device Dissipation @ Free Air	250mW	500mW
Linear Derating Factor	2.3mW/°C	4.3mW/°C

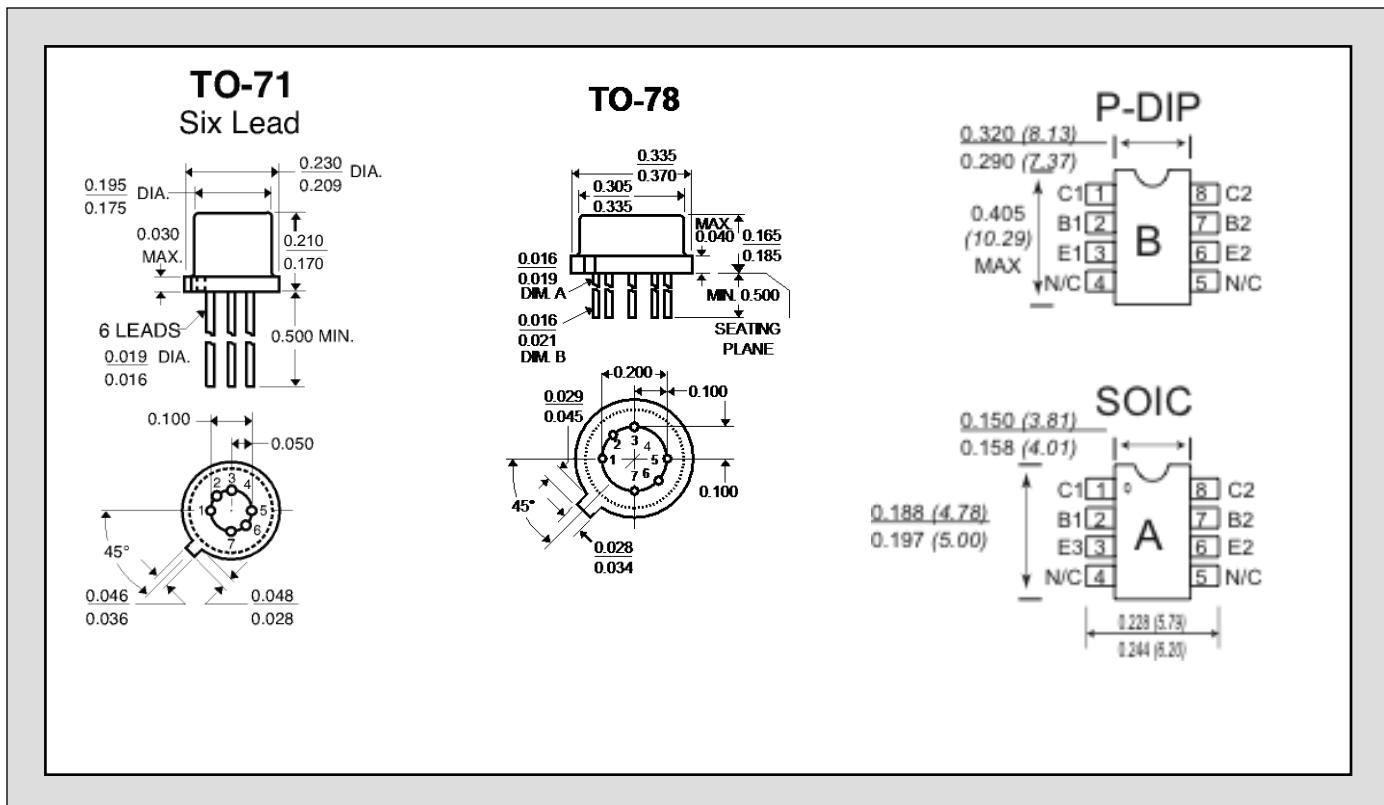


### ELECTRICAL CHARACTERISTICS @ 25°C (unless otherwise noted)

SYMBOL	CHARACTERISTICS	LS310	LS311	LS312	LS313		UNITS	CONDITIONS
BV <sub>CBO</sub>	Collector to Base Voltage	25	45	60	45	MIN.	V	I <sub>C</sub> = 10μA, I <sub>E</sub> = 0
BV <sub>CEO</sub>	Collector to Emitter Voltage	25	45	60	45	MIN.	V	I <sub>C</sub> = 1mA, I <sub>B</sub> = 0
BV <sub>EBO</sub>	Emitter-Base Breakdown Voltage	6.0	6.0	6.0	6.0	MIN.	V	I <sub>E</sub> = 10μA, I <sub>C</sub> = 0 <u>NOTE 2</u>
BV <sub>CCO</sub>	Collector to Collector Voltage	45	45	60	45	MIN.	V	I <sub>C</sub> = 10μA, I <sub>E</sub> = I <sub>B</sub> = 0A
h <sub>FE</sub>	DC Current Gain	150	150	200	400 1000	MIN. MAX.		I <sub>C</sub> = 10μA, V <sub>CE</sub> = 5V
h <sub>FE</sub>	DC Current Gain	150	150	200	400	MIN.		I <sub>C</sub> = 100μA, V <sub>CE</sub> = 5V
h <sub>FE</sub>	DC Current Gain	150	150	200	400	MIN.		I <sub>C</sub> = 1mA, V <sub>CE</sub> = 5V
V <sub>CE(SAT)</sub>	Collector Saturation Voltage	0.25	0.25	0.25	0.25	MAX.	V	I <sub>C</sub> = 1mA, I <sub>B</sub> = 0.1mA
I <sub>CBO</sub>	Collector Cutoff Current	0.2	0.2	0.2	0.2	MAX.	nA	I <sub>E</sub> = 0, V <sub>CB</sub> = <u>NOTE 3</u>
I <sub>EBO</sub>	Emitter Cutoff Current	0.2	0.2	0.2	0.2	MAX.	nA	I <sub>C</sub> = 0, V <sub>CB</sub> = 3V
C <sub>OBO</sub>	Output Capacitance	2	2	2	2	MAX.	pF	I <sub>E</sub> = 0, V <sub>CB</sub> = 5V
C <sub>C1C2</sub>	Collector to Collector Capacitance	2	2	2	2	MAX.	pF	V <sub>CC</sub> = 0V
I <sub>C1C2</sub>	Collector to Collector Leakage Current	1.0	1.0	1.0	1.0	MAX.	μA	V <sub>CC</sub> = <u>NOTE 4</u>
f <sub>T</sub>	Current Gain Bandwidth Product	200	200	200	200	MIN.	MHz	I <sub>C</sub> = 1mA, V <sub>CE</sub> = 5V
NF	Narrow Band Noise Figure	3	3	3	3	MAX.	dB	I <sub>C</sub> = 100μA, V <sub>CE</sub> = 5V BW = 200Hz, R <sub>G</sub> = 10KΩ F=1KHz

**ELECTRICAL CHARACTERISTICS @ 25°C (unless otherwise noted)**

SYMBOL	CHARACTERISTICS	LS310	LS311	LS312	LS313	MIN.	UNITS	CONDITIONS
$ V_{BE1}-V_{BE2} $	Base Emitter Voltage Differential	1 3	0.4 1	0.2 0.5	0.4 1	TYP. MAX.	mV mV	$I_C = 10\mu A, V_{CE} = 5V$
$\Delta(V_{BE1}-V_{BE2})/{}^{\circ}C$	Base Emitter Voltage Differential Change with Temperature	2 15	1 5	0.5 2	1 5	TYP. MAX.	$\mu V/{}^{\circ}C$	$I_C = 10\mu A, V_{CE} = 5V$ $T_A = -55{}^{\circ}C$ to $+125{}^{\circ}C$
$ I_{B1}-I_{B2} $	Base Current Differential			10	5	1.25 5	TYP. MAX.	$nA$ $nA$ $I_C = 10\mu A, V_{CE} = 5V$
$ \Delta(I_{B1}-I_{B2}) /{}^{\circ}C$	Base Current Differential Change with Temperature			0.5	0.3	0.5	MAX.	$nA/{}^{\circ}C$ $I_C = 10\mu A, V_{CE} = 5V$ $T_A = -55{}^{\circ}C$ to $+125{}^{\circ}C$
$h_{FE1}/h_{FE2}$	Current Gain Differential	10	5	5	5	TYP.	%	$I_C = 10\mu A, V_{CE} = 5V$



**NOTES:**

- These ratings are limiting values above which the serviceability of any semiconductor may be impaired.
- The reverse base-to-emitter voltage must never exceed 6.2 volts; the reverse base-to-emitter current must never exceed 10 $\mu A$ .
- For LS310:  $V_{CB} = 20V$ ; for LS311, LS312 & LS313:  $V_{CB} = 30V$
- For LS310, LS311 & LS313:  $V_{CC} \pm 45V$ ; for LS312:  $V_{CC} \pm 60V$ .

Linear Integrated Systems (LIS) is a 25-year-old, third-generation precision semiconductor company providing high-quality discrete components. Expertise brought to LIS is based on processes and products developed at Amelco, Union Carbide, Intersil and Micro Power Systems by company President John H. Hall. Hall, a protégé of Silicon Valley legend Dr. Jean Hoerni, was the director of IC Development at Union Carbide, co-founder and vice president of R&D at Intersil, and founder/president of Micro Power Systems.